

TECHNICAL EVALUATION REPORT
(As Per Rule 35 of PP Rules-2004)

1. Name of Procuring Agency: National Bank of Pakistan
2. Method of Procurement: 36 (b) - Single Stage Two Envelope Procedure,2004
3. Title of Procurement: Procurement of SD – Access (NAC) Solution
4. Tender Inquiry No.: NT-08/14/2023-1
5. PPRA Ref. No. TSE): TS518401E
6. Date & Time of Bid Submission: 21st September 2023 at 3:00 pm
7. Date & Time of Bid Opening: 21st September 2023 at 3:30 pm
8. Number of Bids Received: One (01)
9. Criteria for Bid Evaluation: Mention in standard Bidding document.
10. Details of Bid(s) Evaluation: As follows

Name of Bidder	Technical Marks (If Applicable)	As Per Rule 35 of PP Rules-2004
Silicon ST Pvt Ltd	Non-Responsive	Proposal disqualified due to bidder has not submitted all relevant document as required in SBD

(Divisional Head)
Procurement Division
Logistics, Communications & Marketing Group
Head Office, NBP, Karachi.

Technical Compliance

Bidder's shall quote the solution that comply with the required minimum Technical Specifications along-with its implementation, support and warranty, as any alternate or additional solution will not be considered for evaluation and its bid will be considered as Technically Non-Responsive.

1. For all bidder's requirements against which Bidder is responding "Y", all bidders are required to provide Documentation with proper reference (Section No/ Page No) in the proposal against all requirements. It is mandatory to provide proper reference of document.
2. Bids will be considered non-Responsive if bidder's response with 'N' / 'No' or incomplete response against any of the below criteria.
3. NBP will only raise clarification queries against requirements where reference is provided, and further clarification is required. In case no reference is provided, and documents are not available in the submitted proposal, NBP may not raise any clarification query and response will be considered as NIL, which may lead to disqualification.
4. All bidders are required to affix their company's stamp/signature on each page of the submitted Technical Specifications.